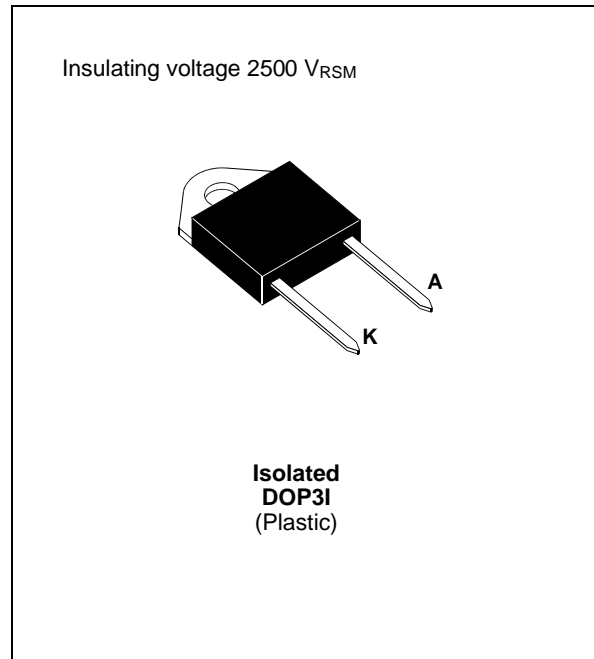


FAST RECOVERY RECTIFIER DIODE

- VERY HIGH REVERSE VOLTAGE CAPABILITY
- VERY LOW REVERSE RECOVERY TIME
- VERY LOW SWITCHING LOSSES
- LOW NOISE TURN-OFF SWITCHING
- INSULATED: Capacitance 15pF



SUITABLE APPLICATIONS

- FREE WHEELING DIODE IN CONVERTERS AND MOTOR CONTROL CIRCUITS
- RECTIFIER IN S.M.P.S.

ABSOLUTE MAXIMUM RATINGS (limiting values)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive Peak Reverse Voltage		1000	V
V _{RSM}	Non Repetitive Peak Reverse Voltage		1000	V
I _{FRM}	Repetive Peak Forward Current	t _p ≤ 10μs	375	A
I _{F (RMS)}	RMS Forward Current		70	A
I _{F (AV)}	Average Forward Current	T _c = 50°C δ = 0.5	30	A
I _{FSM}	Surge non Repetitive Forward Current	t _p = 10ms Sinusoidal	200	A
P	Power Dissipation	T _c = 50°C	60	W
T _{stg} T _j	Storage and Junction Temperature Range		- 40 to +150	°C

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R _{th (j - c)}	Junction-case	1.6	°C/W

ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
I _R	T _j = 25°C	V _R = V _{RRM}			100	μA
	T _j = 100°C				5	mA
V _F	T _j = 25°C	I _F = 30A			1.9	V
	T _j = 100°C				1.8	

RECOVERY CHARACTERISTICS

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
t _{rr}	T _j = 25°C	I _F = 1A	di _F /dt = - 15A/μs	V _R = 30V		165	ns
		I _F = 0.5A	I _R = 1A	I _{rr} = 0.25A		70	

TURN-OFF SWITCHING CHARACTERISTICS (Without Series Inductance)

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
t _{IRM}	di _F /dt = - 120A/μs	V _{CC} = 200 V I _F = 30A L _p ≤ 0.05μH T _j = 100°C See figure 11			200	ns
	di _F /dt = - 240A/μs			120		
I _{RM}	di _F /dt = - 120A/μs				19.5	A
	di _F /dt = - 240A/μs			22		

TURN-OFF OVERVOLTAGE COEFFICIENT (With Series Inductance)

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$C = \frac{V_{RP}}{V_{CC}}$	T _j = 100°C di _F /dt = - 30A/μs	V _{CC} = 200V L _p = 5μH I _F = I _{F(AV)} See figure 12			4.5	

To evaluate the conduction losses use the following equations:

$$V_F = 1.47 + 0.010 I_F \quad P = 1.47 \times I_{F(AV)} + 0.010 I_{F(RMS)}^2$$

Figure 1. Low frequency power losses versus average current

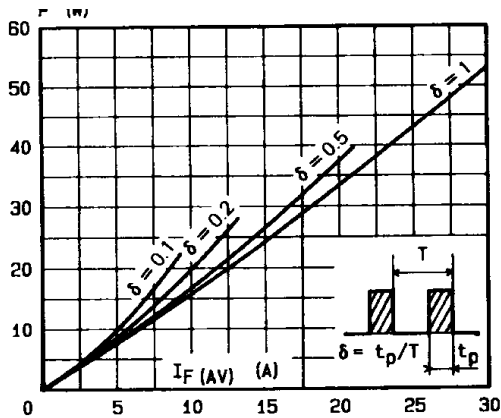


Figure 2. Peak current versus form factor

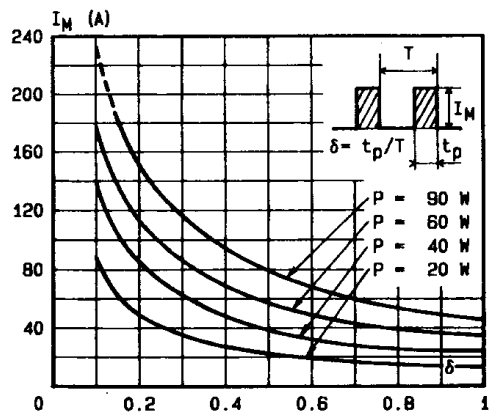


Figure 3. Non repetitive peak surge current versus overload duration

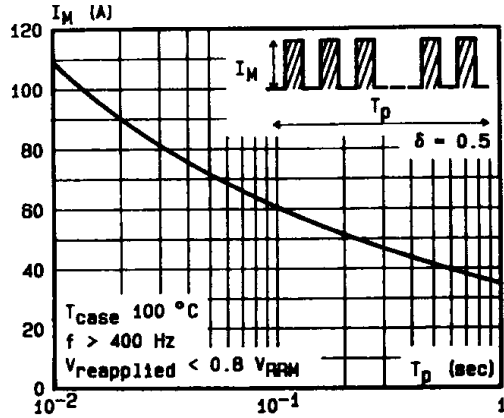


Figure 4. Thermal impedance versus pulse width

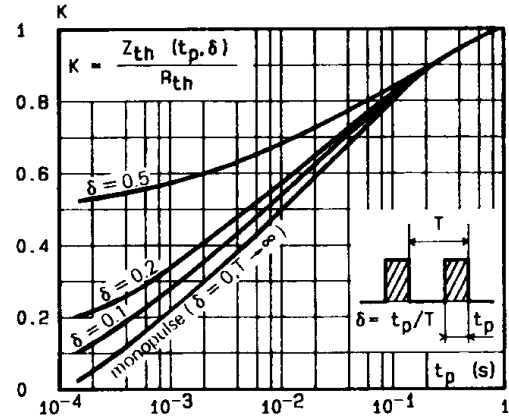


Figure 5. Voltage drop versus forward current

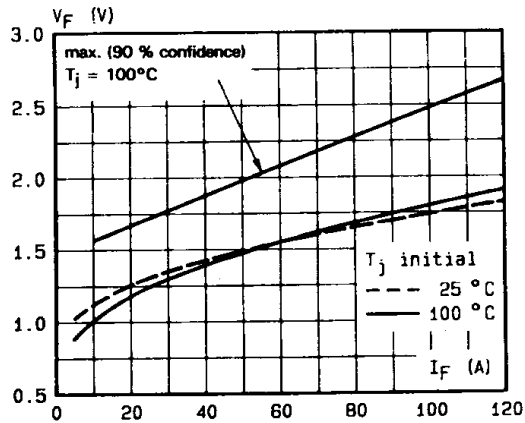


Figure 6. Recovery charge versus di_F/dt

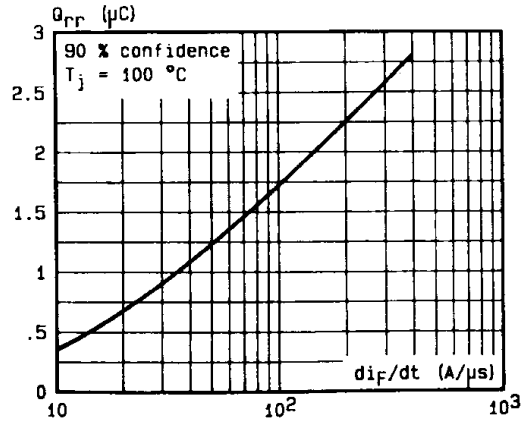


Figure 7. Recovery time versus di_F/dt

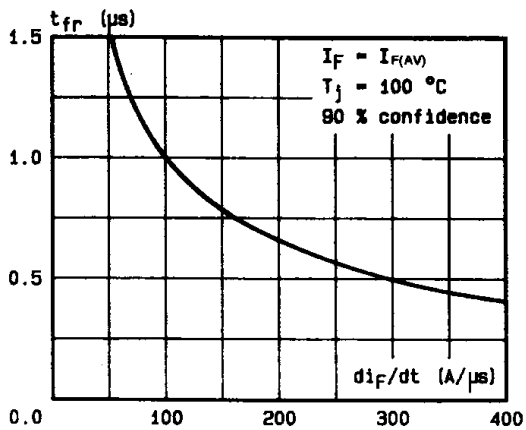


Figure 8. Peak reverse current versus di_F/dt

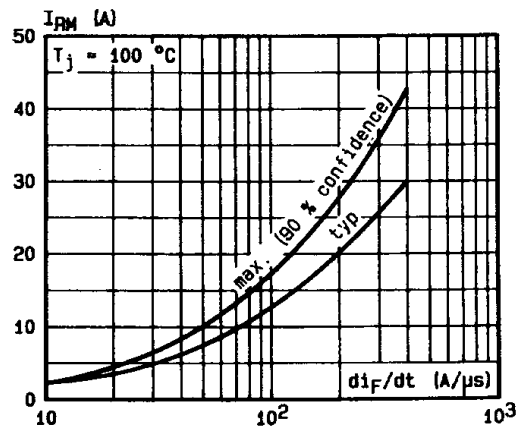


Figure 9. Peak forward voltage versus di_F/dt .

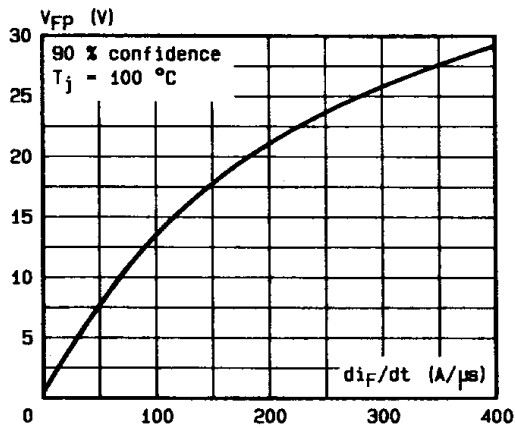


Figure 10. Dynamic parameters versus junction temperature.

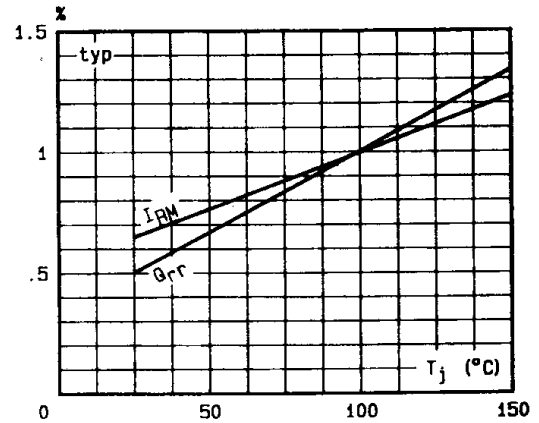


Figure 11. Turn-off switching characteristics (without series inductance).

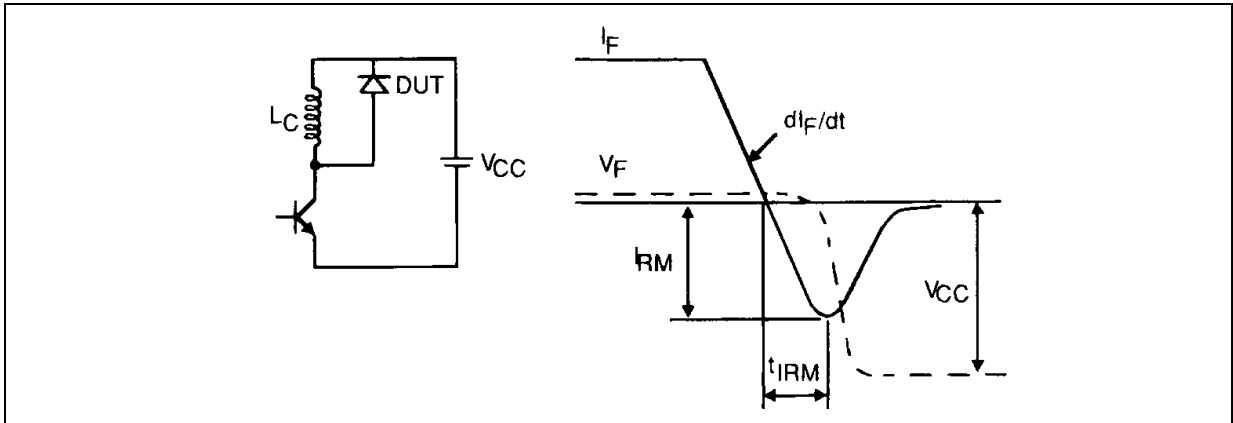
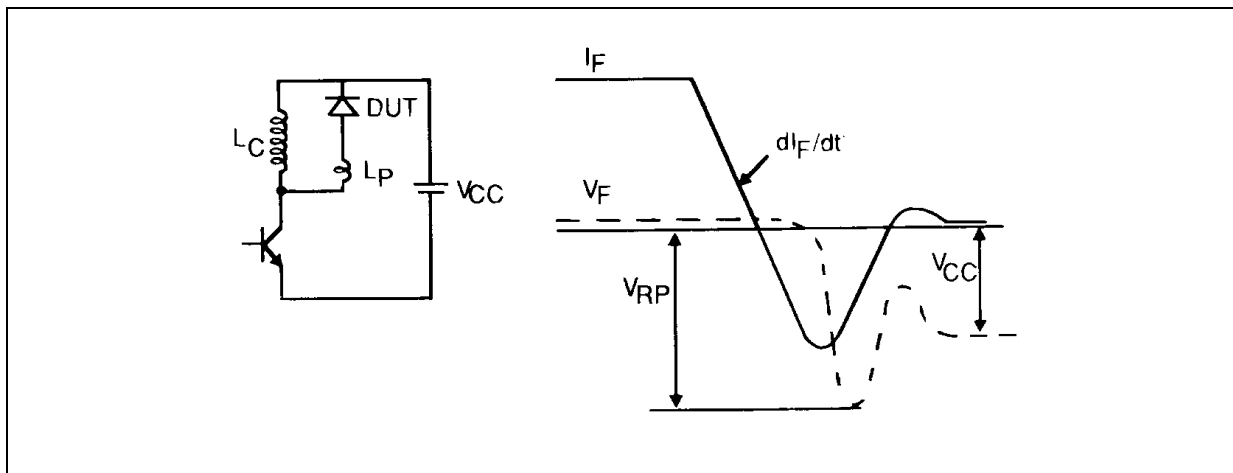
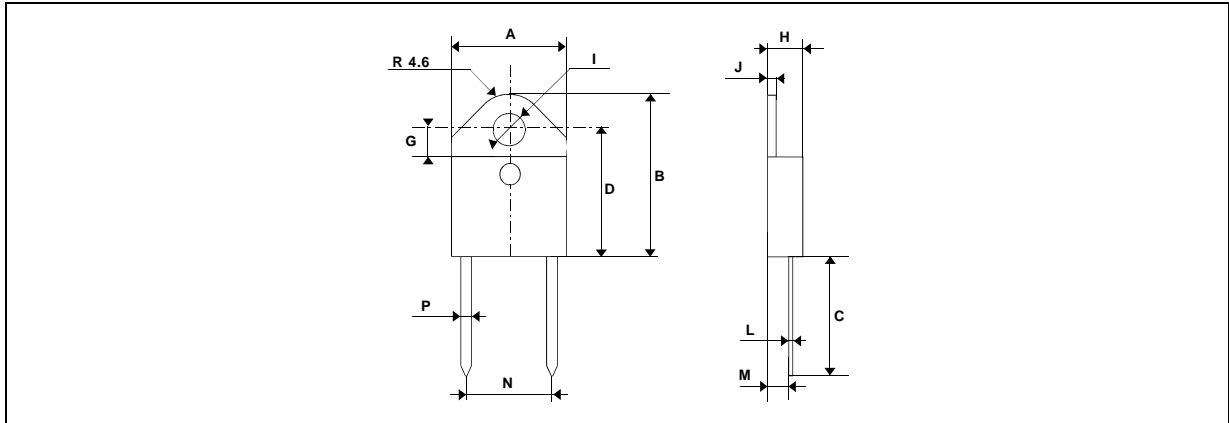


Figure 12. Turn-off switching characteristics (with series inductance)



PACKAGE MECHANICAL DATA : Isolated DOP3I Plastic



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	15.10	15.50	0.594	0.611
B	20.70	21.10	0.814	0.831
C	14.30	15.60	0.561	0.615
D	16.10	16.50	0.632	0.650
G	3.40	-	0.133	-
H	4.40	4.60	0.173	0.182
I	4.08	4.17	0.161	0.164
J	1.45	1.55	0.057	0.062
L	0.50	0.70	0.019	0.028
M	2.70	2.90	0.106	0.115
N	10.80	11.30	0.42	0.45
P	1.20	1.40	0.047	0.056

Cooling method: by conduction (method C)
 Marking: type number
 Weight: 18.84g
 Recommended torque value: 250cm. N
 Maximum torque value: 310cm. N

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